

FDMS039N08B N-Channel PowerTrench[®] MOSFET 80V, 100A, 3.9mΩ

Features

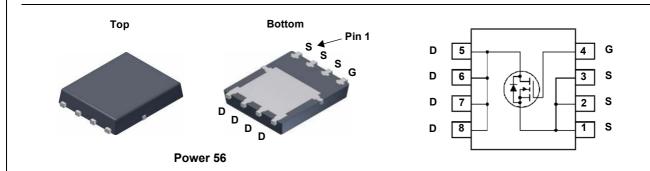
- R_{DS(on)} = 3.2mΩ (Typ.)@ V_{GS} = 10V, I_D = 50A
- Low FOM R_{DS(on)} *Q_G
- Low reverse recovery charge, Q_{rr}
- Soft reverse recovery body diode
- · Enables highly efficiency in synchronous rectification
- Fast Switching Speed
- 100% UIL Tested
- RoHS Compliant

Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Application

- · Synchronous Rectification for Server / Telecom PSU
- Battery Charger and Battery Protection circuit
- DC motor drives and Uninterruptible Power Supplies
- Micro Solar Inverter



MOSFET Maximum Ratings T_C = 25°C unless otherwise noted*

Symbol		Ratings	Units			
V _{DSS}	Drain to Source Voltage	Drain to Source Voltage				
V _{GSS}	Gate to Source Voltage			±20	V	
I _D	Drain Current	- Continuous (T _C = 25 ^o C)		100	•	
		- Continuous (T _A = 25 ^o C)	(Note 1)	19.4	A	
I _{DM}	Drain Current	- Pulsed	(Note 2)	400	Α	
E _{AS}	Single Pulsed Avalanche Energy		(Note 3)	240	mJ	
P _D	Dower Dissinction	(T _C = 25°C)		104	W	
	Power Dissipation	(T _A = 25 ^o C)	(Note 1)	2.5	W	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	

Thermal Characteristics

Symbol	Parameter	Ratings	Units
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.2	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1)	50	0/00

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owerTrench [®]
MOSFET

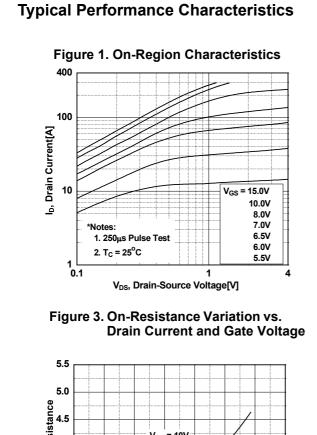
Device MarkingDevicePackageReel SizeTFDMS039N08BFDMS039N08BPower 5613 "		Таре	Tape Width		Quantity					
						2 mm		3000 units		
Electrical	Char	acteristics T _C = 2	25°C unless ot	therwise no	oted					
Symbol		Parameter			est Conditions		Min.	Тур.	Max.	Units
Off Characte	eristic	S					1			1
3V _{DSS}	Drain to	Source Breakdown Vol	tage I	I _D = 250μA	, V _{GS} = 0V		80	-	-	V
	Breakd	own Voltage Temperatur	-	$I_D = 250 \mu A$, Referenced to $25^{\circ}C$			_	0.04	-	V/ºC
ΔT_{J}	Coeffici						-	0.04		_
		ate Voltage Drain Currer		V _{DS} = 64V,			-	-	1	μA
GSS	Gate to	Body Leakage Current	\ \	V _{GS} = ±20\	/, V _{DS} = 0V		-	-	±100	nA
On Characte	eristic	s								
V _{GS(th)}	Gate TI	nreshold Voltage	Y	V _{GS} = V _{DS}	, I _D = 250μA		2.5	-	4.5	V
R _{DS(on)}	Static D	rain to Source On Resis		V _{GS} = 10V,			-	3.2	3.9	mΩ
ĴFS	Forward	d Transconductance		V _{DS} = 10V,	I _D = 50A	(Note 4)	-	100	-	S
Dynamic Ch	aracte	eristics								
-	Input Capacitance						-	5715	7600	pF
	Output	Capacitance		$-V_{DS} = 40V, V_{GS} = 0V$		-	881	1170	pF	
	Reverse	e Transfer Capacitance	i	f = 1MHz		÷	-	15	-	pF
	Engry F	Releted Output Capacita	nce	V _{DS} = 40V	, V _{GS} = 0V		-	1646	-	pF
	Total Ga	ate Charge at 10V		$V_{DS} = 40V, I_{D} = 50A$		-	77	100	nC	
	Gate to	Source Gate Charge		$V_{GS} = 0V t$			-	34	-	nC
	Gate Cl	narge Threshold to Plate	eau				-	13	-	nC
	Gate to	Drain "Miller" Charge				(Note 4,5)	-	16	-	nC
Switching C	harac	teristics	-				·			
-		Delay Time					-	42	94	ns
a(011)		n Rise Time	· · · ·	$V_{DD} = 40V, I_D = 50A$ $V_{GS} = 10V, R_{GEN} = 4.7\Omega$ (Note 4,5)		-	25	60	ns	
	Turn-Of	f Delay Time	· · · · ·			-	48	106	ns	
()	Turn-Of	f Fall Time				-	17	44	ns	
-	Equivalent Series Resistance]	Drain Open, f = 1MHZ			-	1.2	-	Ω
)rain-Sourc	e Dio	de Characteristics	I							
		m Continuous Drain to S		Forward C	urrent		-	_	100	А
0		m Pulsed Drain to Sour					-	_	400	A
0111		Source Diode Forward		V _{GS} = 0V, I			-	-	1.3	V
00		e Recovery Time			_{SD} = 50A, V _{DD}	= 40V	-	68	-	ns
		Recovery Charge		$dI_F/dt = 100$		(Note 4)	-	80	-	nC
otes:	with the de	evice mounted on a 1in ² pad 2 c		1.5 x 1.5 in. b		I. R _{θJC} is guara	anteed by de		don a	

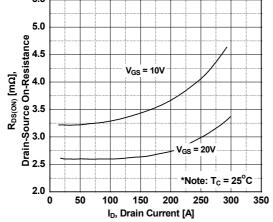
2. Repetitive Rating: Pulse width limited by maximum junction temperature

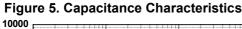
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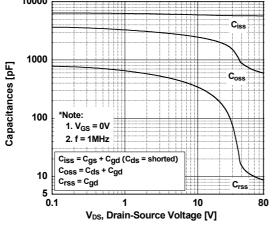
3. L = 0.3mH, I_{AS} = 40A, Starting T_J = 25°C

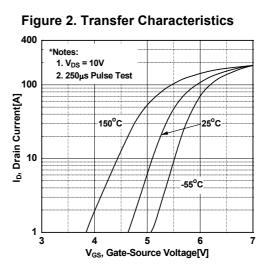
- 4. Pulse Test: Pulse Width $\leq 300~\mu\text{s},$ Duty cycle $\leq 2.0\%$
- 5. Essentially Independent of Operating Temperature Typical Characteristics

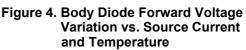












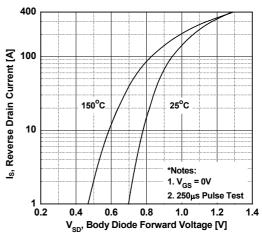
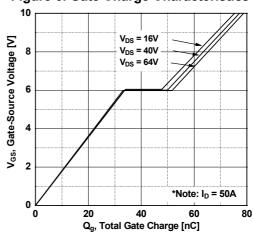
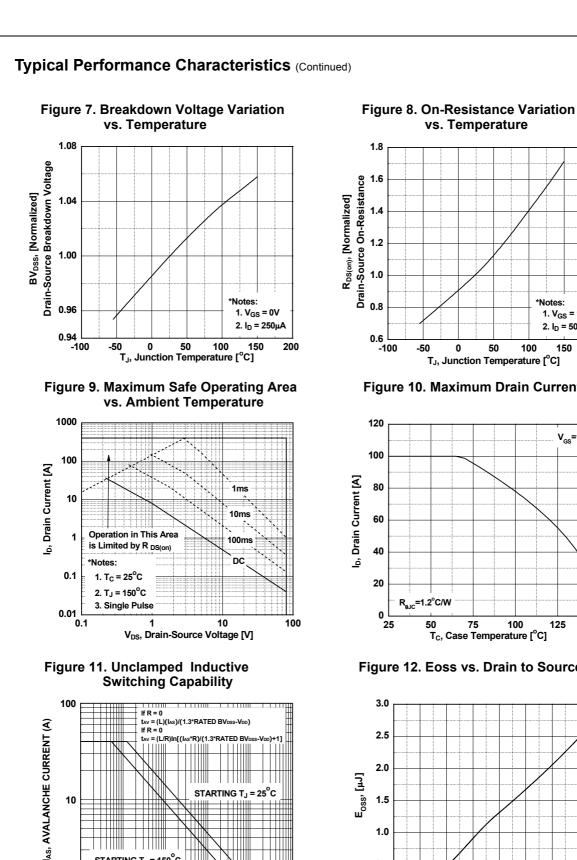
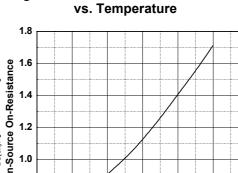


Figure 6. Gate Charge Characteristics







-100 -50 0 50 100 150 T_J, Junction Temperature [^oC]

Notes:

1. V_{GS} = 10V

200

2. I_D = 50A

Figure 10. Maximum Drain Current

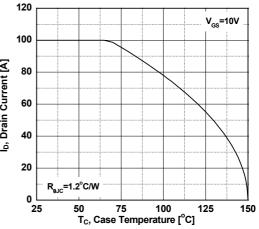
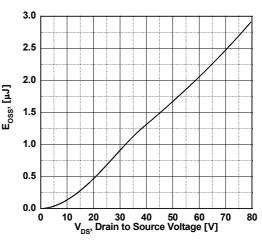


Figure 12. Eoss vs. Drain to Source Voltage



1 – 0.01

STARTING T = $150^{\circ}C$

1

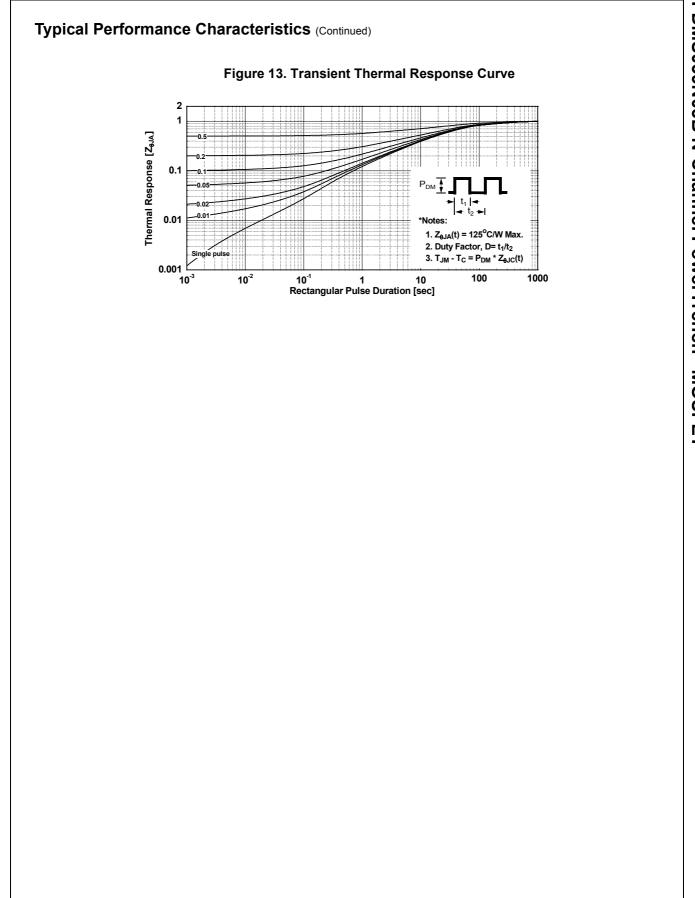
0.1

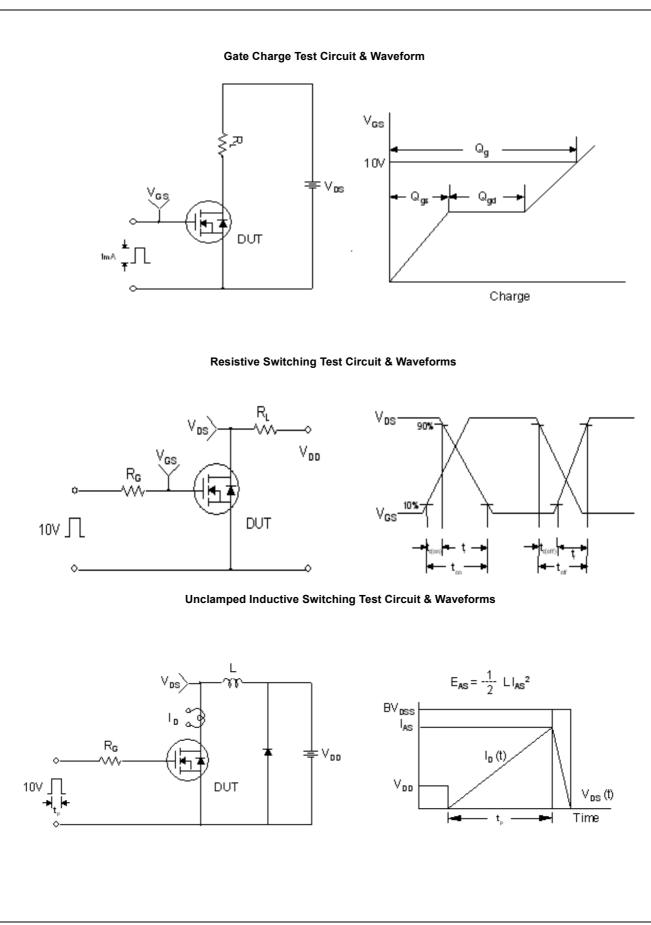
100

10

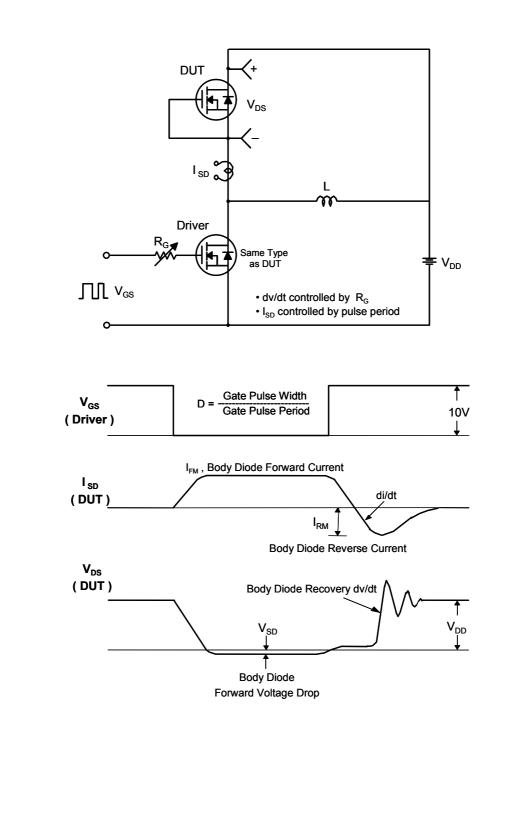
t_{AV}, TIME IN AVALANCHE (ms)

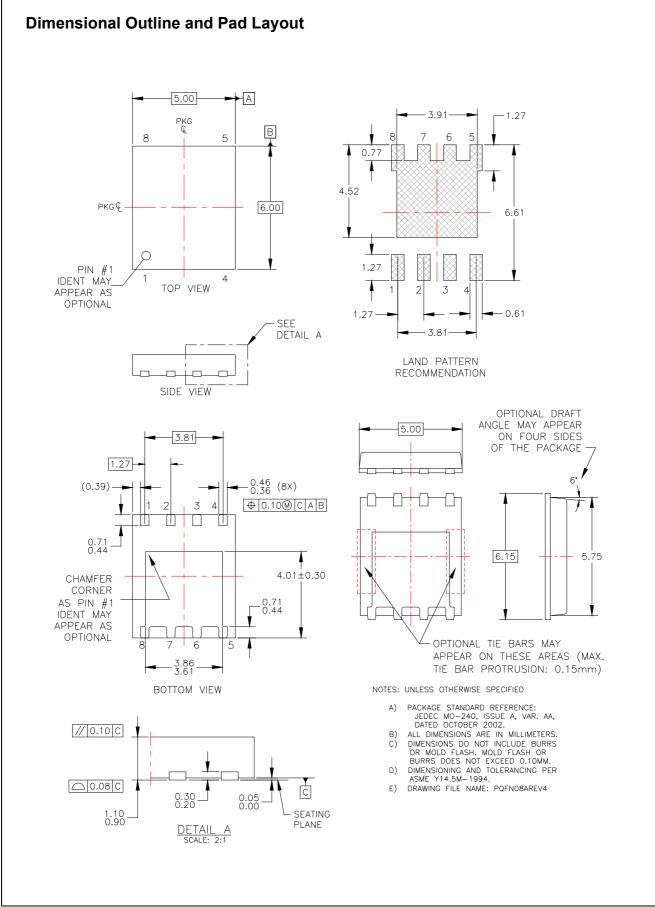
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Peak Diode Recovery dv/dt Test Circuit & Waveforms







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